

## **Description**

The SJPX-H3 is a fast recovery diode of 300 V / 2.0 A. The maximum  $t_{\rm rr}$  of 30 ns is realized by optimizing a life-time control.

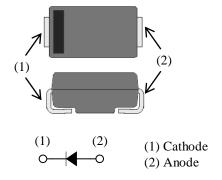
#### **Features**

•	$V_{RM}$	300 <b>v</b>	V
•	$I_{F(AV)}$	2.0 A	4
	V <sub>F</sub>		
•	t <sub>rr1</sub>	30 n	S

- Bare Lead Frame: Pb-free (RoHS Compliant)
- Suitable for High Reliability and Automotive Requirement.

## **Package**

SJP



Not to scale

# Applications

- White Goods
- Audiovisual Equipment
- Lighting Equipment
- Industrial Electronic Equipment (Communication Equipment and Factory Automation)
- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)

## SJPX-H3

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	V <sub>RSM</sub>	300	V	
Repetitive Reverse Voltage	$V_{RM}$	300	V	
Average Forward Current	I <sub>F(AV)</sub>	2.0	A	See Figure 1 and Figure 2
Surge Forward Current	$I_{\mathrm{FSM}}$	20	A	Half cycle sine wave, positive side, 10 ms, 1 shot
I <sup>2</sup> t Limiting Value	$I^2t$	2.0	$A^2s$	$1 \text{ ms} \le t \le 10 \text{ ms}$
Junction Temperature	$T_{J}$	-40 to 150	°C	
Storage Temperature	$T_{STG}$	-40 to 150	°C	

## **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Formand Waltons Drop	$V_{\mathrm{F}}$	$T_J = 25  ^{\circ}\text{C}, I_F = 2.0  \text{A}$	_	_	1.3	V
Forward Voltage Drop		$T_J = 100  ^{\circ}\text{C}, I_F = 2.0  \text{A}$	_	0.92	_	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	_	_	50	μΑ
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 150$ °C			3.0	mA
	t <sub>rr1</sub>	$I_F = I_{RP} = 100 \text{ mA}$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	30	ns
Reverse Recovery Time	t <sub>rr2</sub>	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_		25	ns
Thermal Resistance (1)	R <sub>th(J-L)</sub>				20	°C/W

 $<sup>^{(1)}\,</sup>R_{\text{th (J-L)}}$  is thermal resistance between junction and lead.

## **Rating and Characteristic Curves**

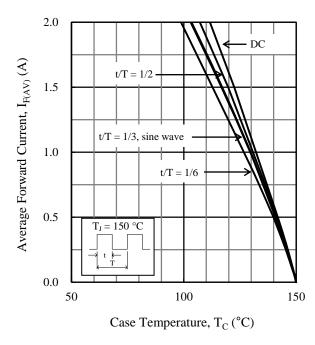


Figure 1.  $T_C \text{ vs. } I_{F(AV)} \text{ Typical Characteristics}$   $(V_R = 0 \text{ V})$ 

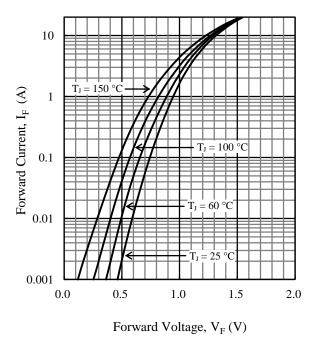


Figure 3. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

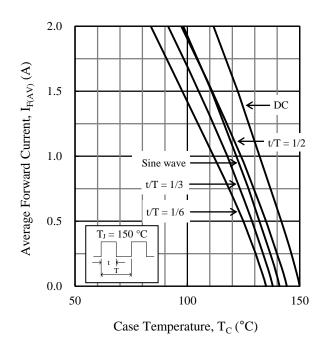


Figure 2.  $T_C$  vs.  $I_{F(AV)}$  Typical Characteristics  $(V_R = 300 \ V)$ 

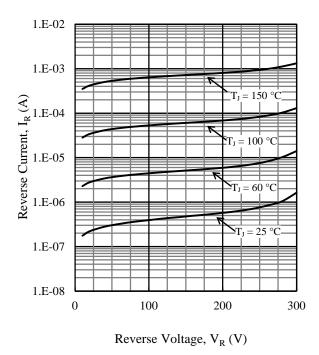
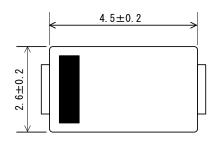
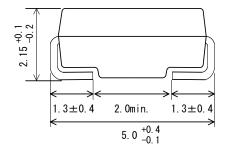


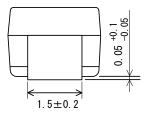
Figure 4. V<sub>R</sub> vs. I<sub>R</sub> Typical Characteristics

## **Physical Dimensions**

#### • SJP Package







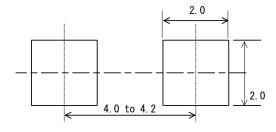
#### **NOTES:**

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits: Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times

Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time

- MSL: JEDEC LEVEL1

#### • SJP Land Pattern Example



#### NOTE:

- Dimensions in millimeters

## **Marking Diagram**

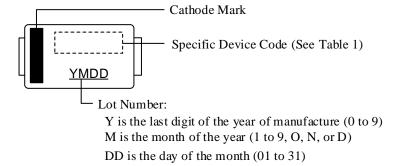


Table 1. Specific Device Code

Specific Device Code	Part Number
XH3	SJPX-H3

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DSGN-AEZ-16003